Atty. Dkt. No. 039153-0472 (G1177)



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Besser et al.

Title:

METHOD OF IMPLANTING

COPPER BARRIER MATERIAL TO

IMPROVE ELECTRICAL

PERFORMANCE

Appl. No.:

09/994,397

Filing

11/26/2001

Date:

Examiner:

Guerrero, Maria F

Art Unit:

2822

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR §1.56

Commissioner for Patents PO Box 1450 Alexandria, Virginia 22313-1450

Sir:

Submitted herewith on Form PTO-1449 is a listing of documents known to Applicants in order to comply with Applicants' duty of disclosure pursuant to 37 CFR3 §1.56. A copy of each listed document is being submitted to comply with the provisions of 37 CFR §1.97 and §1.98.

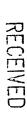
The submission of any document herewith, which is not a statutory bar, is not intended as an admission that such document constitutes prior art against the claims of the present application or that such document is considered material to patentability as defined in 37 CFR §1.56(b). Applicants do not waive any rights to take any action which would be appropriate to antedate or otherwise remove as a competent reference any document which is determined to be a prima facie art reference against the claims of the present application.

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CERTIFICATE OF MAILING I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, Virginia 22313-1450, on the date below. 10000





TIMING OF THE DISCLOSURE

The listed documents are being submitted in compliance with 37 CFR §1.97(d), before payment of the issue fee.

RELEVANCE OF EACH DOCUMENT

All of the documents are in English.

Applicants respectfully request that any listed document be considered by the Examiner and be made of record in the present application and that an initialed copy of Form PTO-1449 be returned in accordance with MPEP §609.

STATEMENT BEST AVAILABLE STATEMENT

The undersigned hereby states in accordance with 37 CFR §1.97(e)(1) that references A1, A3, A6, A9 and A10-A15, contained in this supplemental information disclosure statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three (3) months prior to filing of this Statement.

The undersigned hereby states in accordance with 37 CFR §1.97(e)(2) that references A2, A4-A5 and A7-A8 were not cited in a communication from a foreign patent office in a counterpart foreign application and, to the knowledge of the undersigned, after making reasonable inquiry, references 2-6 were not known individual designated in 37 CFR §1.56(c) more than three months prior to the the supplemental information disclosure statement.

FEE

A fee in connection with submission of a supplemental information disclosure statement under 37 CFR §1.97(d) in the amount of \$180.00 in accordance with 37 CFR §1.17(p) is attached.

The Commissioner is hereby authorized to charge any additional fees which may be required regarding this application under 37 CFR §§ 1.16-1.17, or credit any overpayment, to Deposit Account No. 06-1447. Should no proper payment be enclosed herewith, as by a check being in the wrong amount, unsigned, post-dated, otherwise improper or informal or even entirely missing, the Commissioner is authorized to charge the unpaid amount to Deposit Account No. 06-1447.

Respectfully submitted,

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BEST AVAILABLE CONT

Page 1 of 2 SERIAL NO. N.S. DEPARTMENT OF COMMERCE ATTY. DOCKET NO. Form P/10-1449 09/994,397 039153-0472 (G1177) TENT AND TRADEMARK OFFICE (MODIFIED) AUG 2 5 2003 APPLICANT Besser et al. NFORMATION DISCLOSURE CITATION **GROUP ART UNIT** FILING DATE 2822 11/26/2001 (Use several sheets if necessary) **U.S. PATENT DOCUMENTS** FILING DATE SUB-**DOCUMENT CLASS** 1F **EXAMINER** NAME DATE **CLASS** REF **APPROPRIATE** NUMBER INITIAL 751 257 Lopatin et al. 03/18/2003 6,534,865 **A1** 438 622 Paranjpe et al. 04/02/2002 6,365,502 **A2** 762 257 Shimizu et al. 06/05/2001 6,242,808 A3 678 438 05/01/2001 Ho et al. 6,225,221 A4 659 438 09/12/2000 Pramanick et al. 6,117,770 **A5** 687 Andricacos et al. 438 07/18/2000 6,090,710 A6 628 438 Liu et al. 01/18/2000 6,015,749 **A7** 762 257 Farrar 08/15/2002 2002/0109233 **A8** 430 148 Nagano et al. 11/01/01 2001/0035237 Α9 FOREIGN PATENT DOCUMENTS TRANSLATION SUB DOCUMENT **CLASS** COUNTRY CLASS DATE YES NO REF NUMBER EP 1 094 515 A2 EPO 04/25/2001 A10 **EPO** EP 1 039 531 A2 09/27/2000 A11 **EPO** EP 1 039 531 A3 12/20/2000 A12 **EPO** EP 0 567 867 A2 11/03/1993 A13 OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

| [| | Dong Joon Kim et al, "New Method to Prepare W-B ⁺ -N Ternary Barrier to Cu diffusion by Implanting BF ₂ ⁺ Ions |
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| | A14 | Into W-N Thin Film," J. Vac. Sci. Technol. B 17(4), July/Aug, 1999, pp. 1598-1601. |
| | | W. F. McArthur et al., "Structural and Electrical Characterization of Si-Implanted Tin as a Diffusion Barrier for |
| | A15 | Cu Metallization," Mat. Res. Soc. Symp. Proc. Vol. 391, 1995, pp. 327-332. |
| | A16 | PCT International Search Report, International Application No. PCT/US 02/32605, International Filing Date |
| | | 11/10/2002 (7 pages). |
| | A17 | PCT International search Report, International Application No. PCT/US 02/32554, International Filing Date |
| | | 11/10/2002 (5 pages). |
| | | 11/10/2007 (0.17/20) |

EXAMINER

DATE CONSIDERED

* EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include any copy of this form with next communication to applicant.